

IRF5800PbF

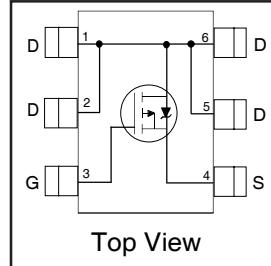
HEXFET® Power MOSFET

- Ultra Low On-Resistance
- P-Channel MOSFET
- Surface Mount
- Available in Tape & Reel
- Low Gate Charge
- Lead-Free
- Halogen-Free

Description

These P-channel MOSFETs from International Rectifier utilize advanced processing techniques to achieve the extremely low on-resistance per silicon area. This benefit provides the designer with an extremely efficient device for use in battery and load management applications.

The TSOP-6 package with its customized leadframe produces a HEXFET® power MOSFET with $R_{DS(on)}$ 60% less than a similar size SOT-23. This package is ideal for applications where printed circuit board space is at a premium. It's unique thermal design and $R_{DS(on)}$ reduction enables a current-handling increase of nearly 300% compared to the SOT-23.



$V_{DSS} = -30V$
 $R_{DS(on)} = 0.085\Omega$



Absolute Maximum Ratings

| | Parameter | Max. | Units |
|--------------------------|--|--------------|---------------|
| V_{DS} | Drain- Source Voltage | -30 | V |
| $I_D @ T_A = 25^\circ C$ | Continuous Drain Current, $V_{GS} @ -4.5V$ | -4.0 | |
| $I_D @ T_A = 70^\circ C$ | Continuous Drain Current, $V_{GS} @ -4.5V$ | -3.2 | A |
| I_{DM} | Pulsed Drain Current ① | -32 | |
| $P_D @ T_A = 25^\circ C$ | Power Dissipation | 2.0 | |
| $P_D @ T_A = 70^\circ C$ | Power Dissipation | 1.3 | W |
| | Linear Derating Factor | 0.016 | W/ $^\circ C$ |
| E_{AS} | Single Pulse Avalanche Energy ④ | 20.6 | mJ |
| V_{GS} | Gate-to-Source Voltage | ± 20 | V |
| T_J, T_{STG} | Junction and Storage Temperature Range | -55 to + 150 | $^\circ C$ |

Thermal Resistance

| | Parameter | Max. | Units |
|-----------|-------------------------------|------|--------------|
| R_{QJA} | Maximum Junction-to-Ambient ③ | 62.5 | $^\circ C/W$ |

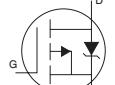
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Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|---|--------------------------------------|------|------|-------|--------------------------|--|
| $V_{(\text{BR})\text{DSS}}$ | Drain-to-Source Breakdown Voltage | -30 | — | — | V | $V_{\text{GS}} = 0\text{V}$, $I_D = -250\mu\text{A}$ |
| $\Delta V_{(\text{BR})\text{DSS}/\Delta T_J}$ | Breakdown Voltage Temp. Coefficient | — | 0.02 | — | V°C | Reference to 25°C , $I_D = 1\text{mA}$ |
| $R_{\text{DS}(\text{on})}$ | Static Drain-to-Source On-Resistance | — | — | 0.085 | Ω | $V_{\text{GS}} = -10\text{V}$, $I_D = -4.0\text{A}$ ② |
| | | — | — | 0.150 | | $V_{\text{GS}} = -4.5\text{V}$, $I_D = -3.0\text{A}$ ② |
| $V_{\text{GS}(\text{th})}$ | Gate Threshold Voltage | -1.0 | — | — | V | $V_{\text{DS}} = V_{\text{GS}}$, $I_D = -250\mu\text{A}$ |
| g_{fs} | Forward Transconductance | 3.5 | — | — | S | $V_{\text{DS}} = -10\text{V}$, $I_D = -4.0\text{A}$ |
| I_{DSS} | Drain-to-Source Leakage Current | — | — | -1.0 | μA | $V_{\text{DS}} = -24\text{V}$, $V_{\text{GS}} = 0\text{V}$ |
| | | — | — | -5.0 | | $V_{\text{DS}} = -24\text{V}$, $V_{\text{GS}} = 0\text{V}$, $T_J = 70^\circ\text{C}$ |
| I_{GSS} | Gate-to-Source Forward Leakage | — | — | -100 | nA | $V_{\text{GS}} = -20\text{V}$ |
| | Gate-to-Source Reverse Leakage | — | — | 100 | | $V_{\text{GS}} = 20\text{V}$ |
| Q_g | Total Gate Charge | — | 11.4 | 17 | nC | $I_D = -4.0\text{A}$ |
| Q_{gs} | Gate-to-Source Charge | — | 2.3 | — | | $V_{\text{DS}} = -16\text{V}$ |
| Q_{gd} | Gate-to-Drain ("Miller") Charge | — | 2.2 | — | | $V_{\text{GS}} = -10\text{V}$ ② |
| $t_{\text{d}(\text{on})}$ | Turn-On Delay Time | — | 11.4 | 17 | ns | $V_{\text{DD}} = -15\text{V}$, $V_{\text{GS}} = -10\text{V}$ |
| t_r | Rise Time | — | 11 | 17 | | $I_D = -1.0\text{A}$ |
| $t_{\text{d}(\text{off})}$ | Turn-Off Delay Time | — | 24 | 36 | | $R_G = 6.0\Omega$ |
| t_f | Fall Time | — | 14 | 20 | | $R_D = 15\Omega$, ② |
| C_{iss} | Input Capacitance | — | 535 | — | pF | $V_{\text{GS}} = 0\text{V}$ |
| C_{oss} | Output Capacitance | — | 94 | — | | $V_{\text{DS}} = -25\text{V}$ |
| C_{rss} | Reverse Transfer Capacitance | — | 68 | — | | $f = 1.0\text{MHz}$ |

Source-Drain Ratings and Characteristics

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|-----------------|--|------|------|------|-------|---|
| I_S | Continuous Source Current (Body Diode) | — | — | -2.0 | A | MOSFET symbol showing the integral reverse p-n junction diode. |
| I_{SM} | Pulsed Source Current (Body Diode) ① | — | — | -32 | |  |
| V_{SD} | Diode Forward Voltage | — | — | -1.2 | V | $T_J = 25^\circ\text{C}$, $I_S = -2.0\text{A}$, $V_{\text{GS}} = 0\text{V}$ ② |
| t_{rr} | Reverse Recovery Time | — | 19 | 28 | ns | $T_J = 25^\circ\text{C}$, $I_F = -2.0\text{A}$ |
| Q_{rr} | Reverse Recovery Charge | — | 16 | 24 | nC | $dI/dt = -100\text{A}/\mu\text{s}$ ② |

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Pulse width $\leq 300\mu\text{s}$; duty cycle $\leq 2\%$.
- ③ Surface mounted on FR-4 board, $t \leq 5\text{sec}$.
- ④ Starting $T_J = 25^\circ\text{C}$, $L = 2.5\text{mH}$
 $R_G = 25\Omega$, $I_{AS} = -4.0\text{A}$. (See Fig 10)

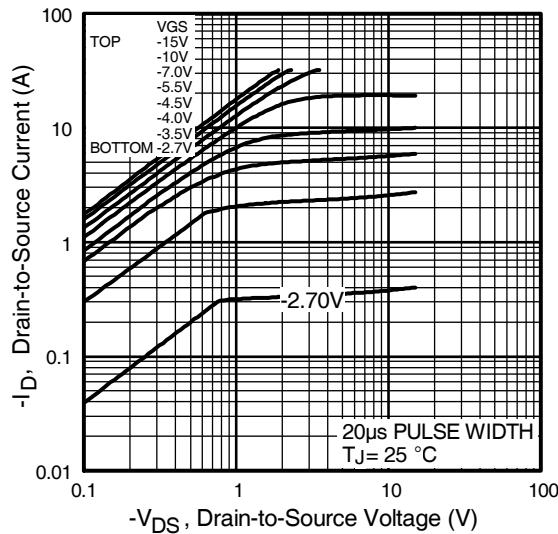


Fig 1. Typical Output Characteristics

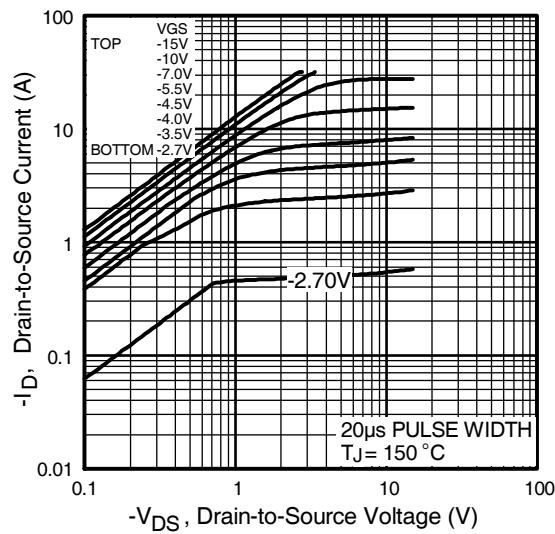


Fig 2. Typical Output Characteristics

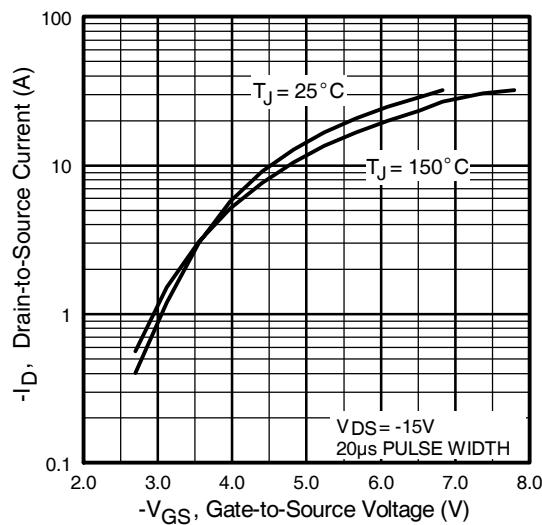


Fig 3. Typical Transfer Characteristics

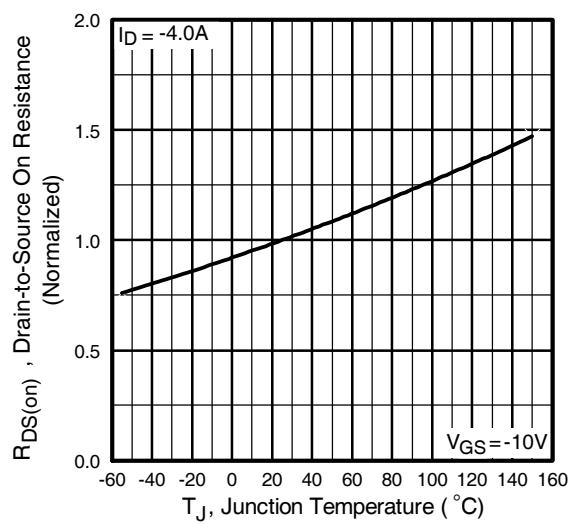


Fig 4. Normalized On-Resistance
Vs. Temperature

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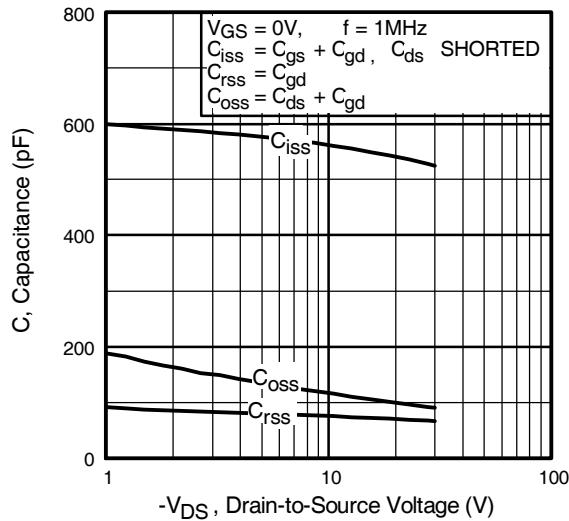


Fig 5. Typical Capacitance Vs.
Drain-to-Source Voltage

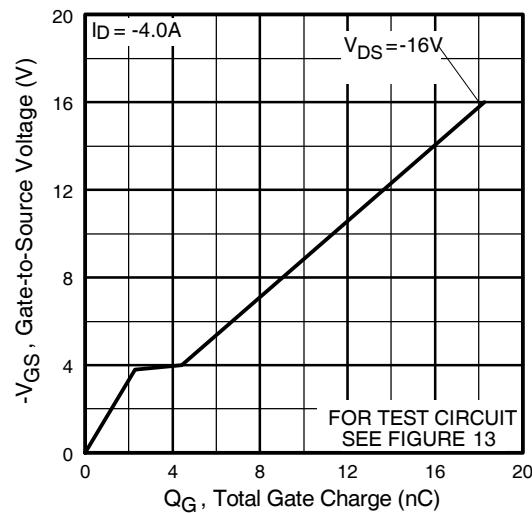


Fig 6. Typical Gate Charge Vs.
Gate-to-Source Voltage

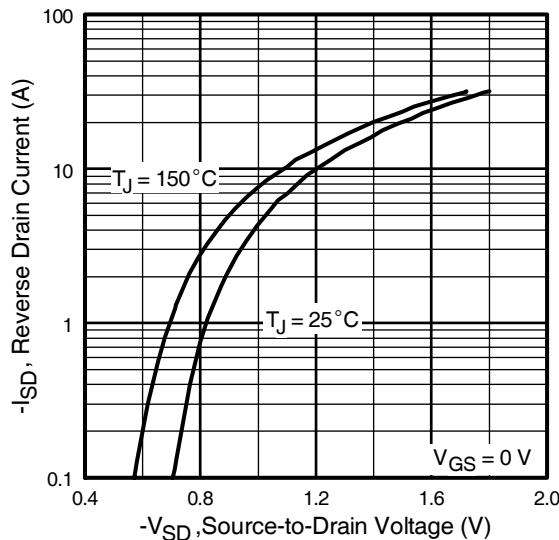


Fig 7. Typical Source-Drain Diode
Forward Voltage

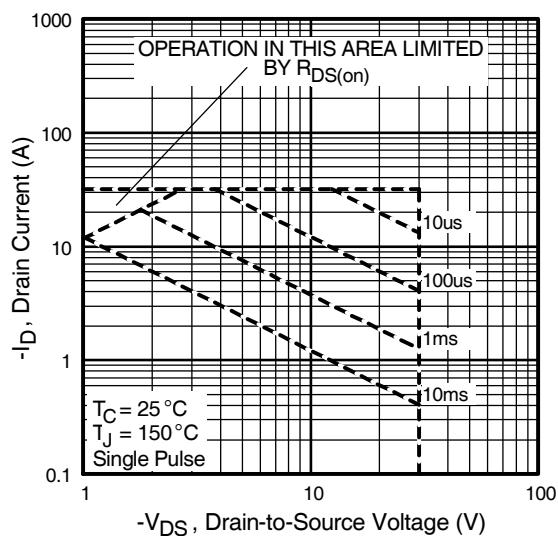


Fig 8. Maximum Safe Operating Area

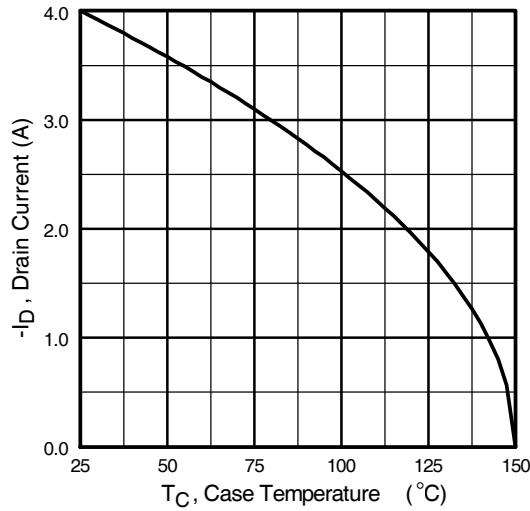


Fig 9. Maximum Drain Current Vs.
Case Temperature

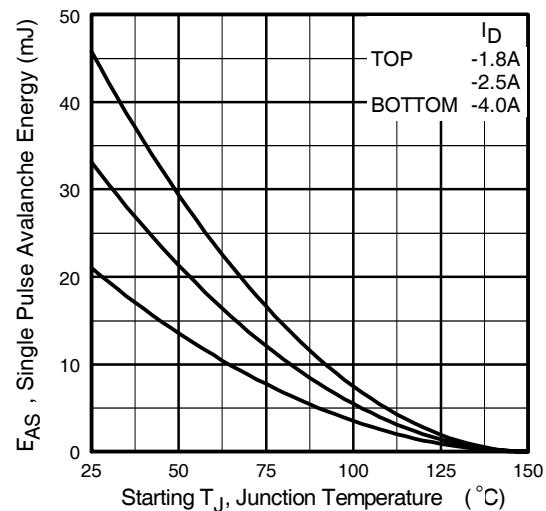


Fig 10. Maximum Avalanche Energy
Vs. Drain Current

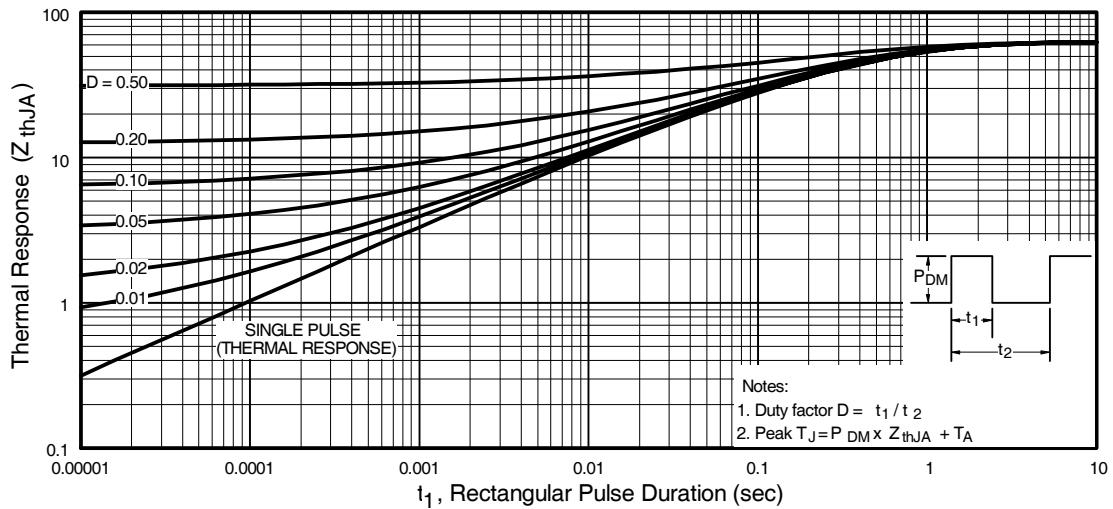


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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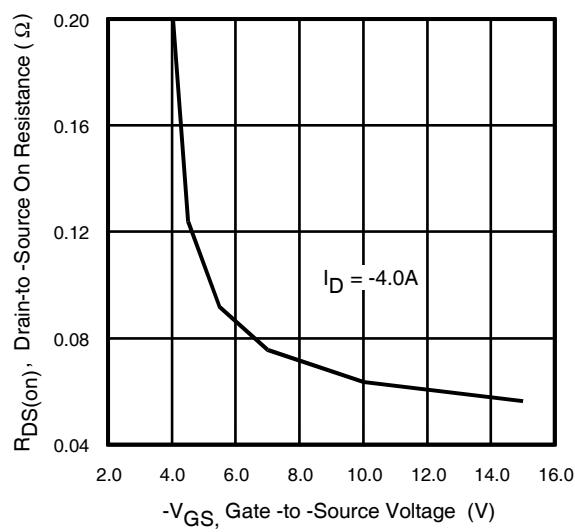


Fig 12. Typical On-Resistance Vs.
Gate Voltage

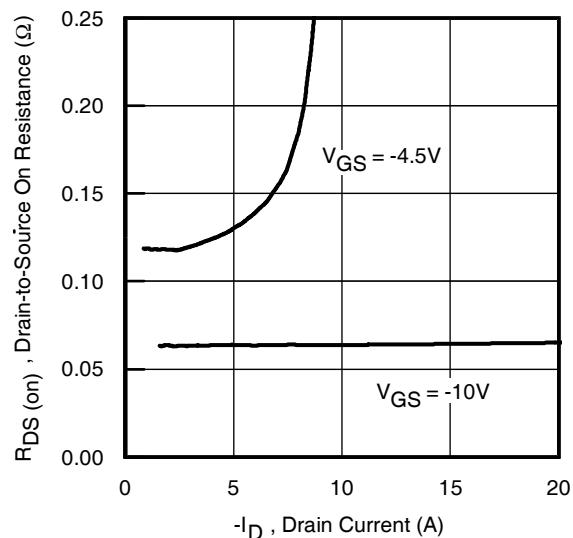
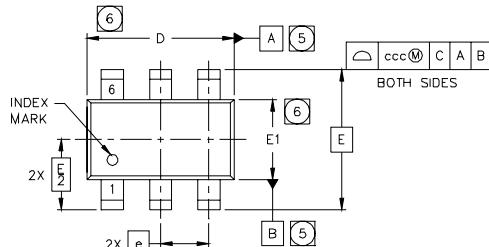


Fig 13. Typical On-Resistance Vs.
Drain Current

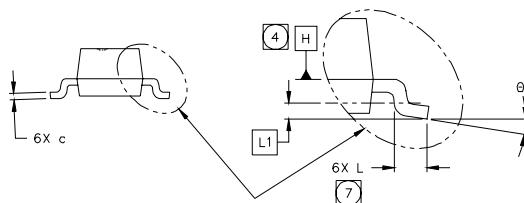
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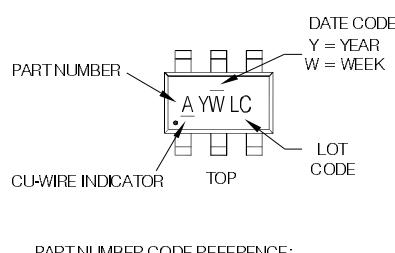
TSOP-6 Package Outline



| SYM BOL | MO-193AA DIMENSIONS | | | | | |
|------------|---------------------|------|------|--------|-------|-------|
| | MILLIMETERS | | | INCHES | | |
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | --- | --- | 1.10 | --- | --- | .0433 |
| A1 | 0.01 | --- | 0.10 | .0004 | --- | .0039 |
| A2 | 0.80 | 0.90 | 1.00 | .0315 | .0354 | .0393 |
| b | 0.25 | --- | 0.50 | .0099 | --- | .0196 |
| c | 0.10 | --- | 0.26 | .004 | --- | .010 |
| D | 2.90 | 3.00 | 3.10 | .115 | .118 | .122 |
| E | 2.75 | BSC | | .108 | BSC | |
| E1 | 1.30 | 1.50 | 1.70 | .052 | .059 | .066 |
| e | | 1.00 | BSC | | .039 | BSC |
| L | 0.20 | 0.40 | 0.60 | .0079 | .0157 | .0236 |
| L1 | | 0.30 | BSC | | .018 | BSC |
| θ | 0° | --- | 8° | 0° | --- | 8° |
| aaa | | 0.10 | | | .004 | |
| bbb | | 0.15 | | | .006 | |
| ccc | | 0.25 | | | .010 | |



TSOP-6 Part Marking Information



PART NUMBER CODE REFERENCE:

- A = SI3443DV K = IRF5810
- B = IRF5800 L = IRF5804
- C = IRF5850 M = IRF5803
- D = IRF5851 N = IRF5802
- E = IRF5852
- F = IRF5801
- I = IRF5805
- J = IRF5806

Notes:

- A line above the work week (as shown here) indicates Lead-Free
- A line below the part number (as shown here) indicates Cu-wire

W = (1-26) IF PRECEDED BY LAST DIGIT OF CALENDAR YEAR

| YEAR | Y | WORK WEEK | W |
|------|---|-----------|---|
| 2001 | 1 | 01 | A |
| 2002 | 2 | 02 | B |
| 2003 | 3 | 03 | C |
| 2004 | 4 | 04 | D |
| 2005 | 5 | | |
| 2006 | 6 | | |
| 2007 | 7 | | |
| 2008 | 8 | | |
| 2009 | 9 | | |
| 2010 | 0 | 24 | X |
| | | 25 | Y |
| | | 26 | Z |

W = (27-52) IF PRECEDED BY A LETTER

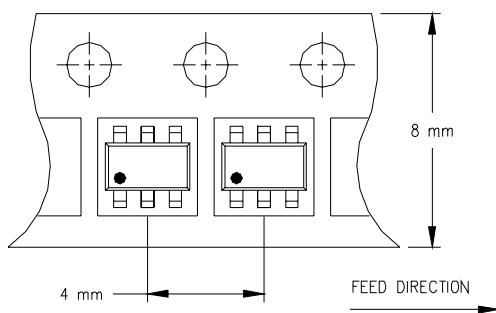
| YEAR | Y | WORK WEEK | W |
|------|---|-----------|---|
| 2001 | A | 27 | A |
| 2002 | B | 28 | B |
| 2003 | C | 29 | C |
| 2004 | D | 30 | D |
| 2005 | E | | |
| 2006 | F | | |
| 2007 | G | | |
| 2008 | H | | |
| 2009 | J | | |
| 2010 | K | 50 | X |
| | | 51 | Y |
| | | 52 | Z |

Note: For the most current drawing please refer to IR website at: <http://www.irf.com/package/>
www.irf.com

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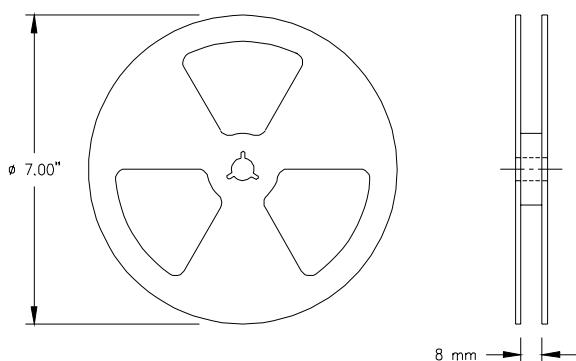
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TSOP-6 Tape & Reel Information



NOTES:

1. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES:

1. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Data and specifications subject to change without notice.
This product has been designed and qualified for the Consumer market.
Qualifications Standards can be found on IR's Web site.

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